

# E1SCA18-5.9904M

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## REGULATORY COMPLIANCE (Data Sheet downloaded on Aug 17, 2016)


[Click badges to download compliance docs](#)

Regulatory Compliance standards are subject to updates by governing bodies. Click the badges to download the latest compliance docs for this part number directly from Ecliptek.



## ITEM DESCRIPTION

Quartz Crystal Resonator HC49/UP Short 2 Pad Surface Mount (SMD) 3.2mm Height Metal Resistance Weld Seal 5.9904MHz  $\pm 50$ ppm at 25°C,  $\pm 100$ ppm over -40°C to +85°C 18pF Parallel Resonant

## ELECTRICAL SPECIFICATIONS

|                               |                                                         |
|-------------------------------|---------------------------------------------------------|
| Nominal Frequency             | 5.9904MHz                                               |
| Frequency Tolerance/Stability | $\pm 50$ ppm at 25°C, $\pm 100$ ppm over -40°C to +85°C |
| Aging at 25°C                 | $\pm 5$ ppm/year Maximum                                |
| Load Capacitance              | 18pF Parallel Resonant                                  |
| Shunt Capacitance             | 7pF Maximum                                             |
| Equivalent Series Resistance  | 150 Ohms Maximum                                        |
| Mode of Operation             | AT-Cut Fundamental                                      |
| Drive Level                   | 1mWatt Maximum                                          |
| Storage Temperature Range     | -55°C to +125°C                                         |
| Insulation Resistance         | 500 Megaohms Minimum (Measured at 100Vdc)               |

## ENVIRONMENTAL & MECHANICAL SPECIFICATIONS

|                              |                                               |
|------------------------------|-----------------------------------------------|
| ESD Susceptibility           | MIL-STD-883, Method 3015, Class 1, HBM: 1500V |
| Fine Leak Test               | MIL-STD-883, Method 1014, Condition A         |
| Flammability                 | UL94-V0                                       |
| Gross Leak Test              | MIL-STD-883, Method 1014, Condition C         |
| Mechanical Shock             | MIL-STD-202, Method 213, Condition C          |
| Moisture Resistance          | MIL-STD-883, Method 1004                      |
| Moisture Sensitivity         | J-STD-020, MSL1                               |
| Resistance to Soldering Heat | MIL-STD-202, Method 210, Condition K          |
| Resistance to Solvents       | MIL-STD-202, Method 215                       |
| Solderability                | MIL-STD-883, Method 2003                      |
| Temperature Cycling          | MIL-STD-883, Method 1010, Condition B         |
| Vibration                    | MIL-STD-883, Method 2007, Condition A         |

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MECHANICAL DIMENSIONS (all dimensions in millimeters)



| LINE | MARKING                           |
|------|-----------------------------------|
| 1    | E5.9904M<br>E=Ecliptek Designator |

Suggested Solder Pad Layout

All Dimensions in Millimeters



All Tolerances are ±0.1

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Recommended Solder Reflow Methods



High Temperature Infrared/Convection

|                                     |                                      |
|-------------------------------------|--------------------------------------|
| Ts MAX to Tl (Ramp-up Rate)         | 3°C/Second Maximum                   |
| Preheat                             |                                      |
| - Temperature Minimum (Ts MIN)      | 150°C                                |
| - Temperature Typical (Ts TYP)      | 175°C                                |
| - Temperature Maximum (Ts MAX)      | 200°C                                |
| - Time (ts MIN)                     | 60 - 180 Seconds                     |
| Ramp-up Rate (Tl to Tp)             | 3°C/Second Maximum                   |
| Time Maintained Above:              |                                      |
| - Temperature (Tl)                  | 217°C                                |
| - Time (tL)                         | 60 - 150 Seconds                     |
| Peak Temperature (Tp)               | 260°C Maximum for 10 Seconds Maximum |
| Target Peak Temperature (Tp Target) | 250°C +0/-5°C                        |
| Time within 5°C of actual peak (tp) | 20 - 40 Seconds                      |
| Ramp-down Rate                      | 6°C/Second Maximum                   |
| Time 25°C to Peak Temperature (t)   | 8 Minutes Maximum                    |
| Moisture Sensitivity Level          | Level 1                              |

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Recommended Solder Reflow Methods



Low Temperature Infrared/Convection 245°C

|                                     |                                                        |
|-------------------------------------|--------------------------------------------------------|
| Ts MAX to Tl (Ramp-up Rate)         | 5°C/Second Maximum                                     |
| Preheat                             |                                                        |
| - Temperature Minimum (Ts MIN)      | N/A                                                    |
| - Temperature Typical (Ts TYP)      | 150°C                                                  |
| - Temperature Maximum (Ts MAX)      | N/A                                                    |
| - Time (ts MIN)                     | 30 - 60 Seconds                                        |
| Ramp-up Rate (Tl to Tp)             | 5°C/Second Maximum                                     |
| Time Maintained Above:              |                                                        |
| - Temperature (Tl)                  | 150°C                                                  |
| - Time (tL)                         | 200 Seconds Maximum                                    |
| Peak Temperature (Tp)               | 245°C Maximum                                          |
| Target Peak Temperature (Tp Target) | 245°C Maximum 2 Times / 230°C Maximum 1 Time           |
| Time within 5°C of actual peak (tp) | 10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time |
| Ramp-down Rate                      | 5°C/Second Maximum                                     |
| Time 25°C to Peak Temperature (t)   | N/A                                                    |
| Moisture Sensitivity Level          | Level 1                                                |

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum.

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum.